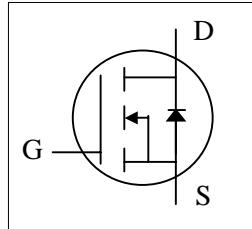
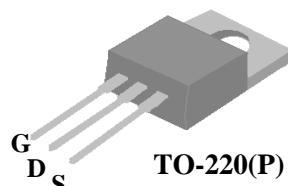
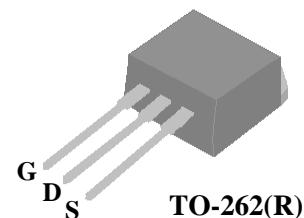




- ▼ 100% Avalanche Rated Test
- ▼ Fast Switching Performance
- ▼ Simple Drive Requirement
- ▼ RoHS Compliant



BV_{DSS}	650V
$R_{DS(ON)}$	0.6Ω
I_D	10A



Description

AP10N70 series are specially designed as main switching devices for universal 90~265VAC off-line AC/DC converter applications. Both TO-220 and TO-262 type provide high blocking voltage to overcome voltage surge and sag in the toughest power system with the best combination of fast switching, ruggedized design and cost-effectiveness.

The TO-220 and TO-262 package is universally preferred for all commercial-industrial applications. The device is suited for switch mode power supplies, DC-AC converters and high current high speed switching circuits.

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	650	V
V_{GS}	Gate-Source Voltage	± 30	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	10	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	6.8	A
I_{DM}	Pulsed Drain Current ¹	40	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	174	W
	Linear Derating Factor	1.39	W/ $^\circ C$
E_{AS}	Single Pulse Avalanche Energy ²	50	mJ
I_{AR}	Avalanche Current	10	A
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Value	Unit
R_{thj-c}	Thermal Resistance Junction-case	Max. 0.72	$^\circ C/W$
R_{thj-a}	Thermal Resistance Junction-ambient	Max. 62	$^\circ C/W$



Electrical Characteristics@ $T_j=25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=1.0mA$	650	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=5.0A$	-	-	0.6	Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2	-	4	V
g_{fs}	Forward Transconductance	$V_{DS}=10V, I_D=5A$	5	-	-	S
I_{DSS}	Drain-Source Leakage Current ($T_j=25^\circ C$)	$V_{DS}=600V, V_{GS}=0V$	-	-	10	μA
	Drain-Source Leakage Current ($T_j=150^\circ C$)	$V_{DS}=480V, V_{GS}=0V$	-	-	100	μA
I_{GSS}	Gate-Source Leakage	$V_{GS}=\pm 30V$	-	-	± 100	nA
Q_g	Total Gate Charge ³	$I_D=10A$	-	35.9	57	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=480V$	-	8.3	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=10V$	-	11.5	-	nC
$t_{d(on)}$	Turn-on Delay Time ³	$V_{DD}=300V$	-	14.9	-	ns
t_r	Rise Time	$I_D=10A$	-	19.7	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=10\Omega, V_{GS}=10V$	-	51.7	-	ns
t_f	Fall Time	$R_D=30\Omega$	-	23.3	-	ns
C_{iss}	Input Capacitance	$V_{GS}=0V$	-	1950	3120	pF
C_{oss}	Output Capacitance	$V_{DS}=15V$	-	630	-	pF
C_{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	20	-	pF
R_g	Gate Resistance	f=1.0MHz	-	2	3	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ³	$T_j=25^\circ C, I_S=10A, V_{GS}=0V$	-	-	1.5	V
t_{rr}	Reverse Recovery Time ²	$I_S=10A, V_{GS}=0V,$ $dI/dt=100A/\mu s$	-	640	-	ns
	Reverse Recovery Charge		-	7460	-	nC

Notes:

- 1.Pulse width limited by safe operating area.
- 2.Starting $T_j=25^\circ C$, $V_{DD}=50V$, $L=1.0mH$, $R_G=25\Omega$, $I_{AS}=10A$.
- 3.Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

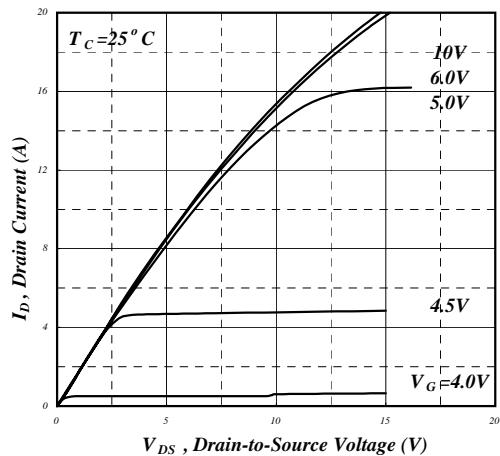


Fig 1. Typical Output Characteristics

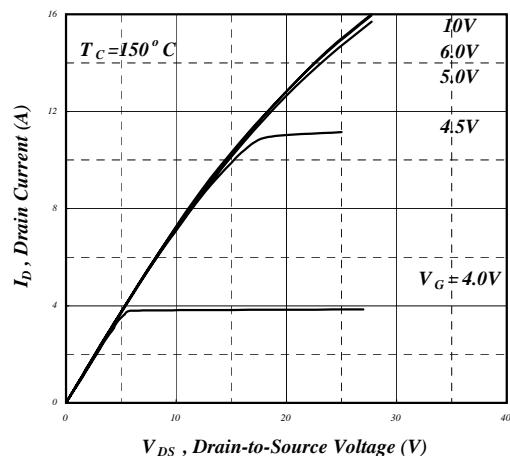


Fig 2. Typical Output Characteristics

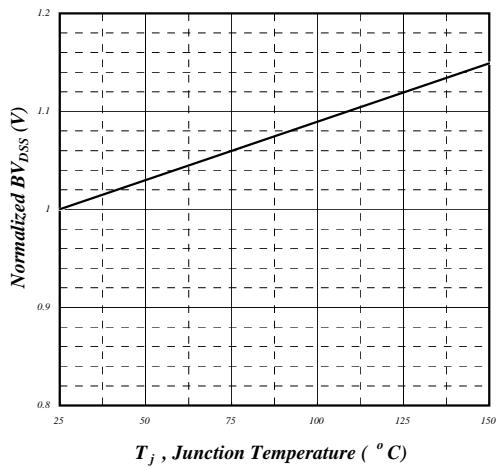
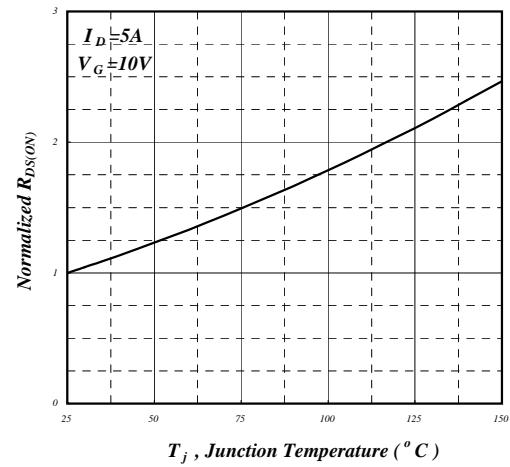
Fig 3. Normalized BV_{DSS} v.s. Junction Temperature

Fig 4. Normalized On-Resistance v.s. Junction Temperature

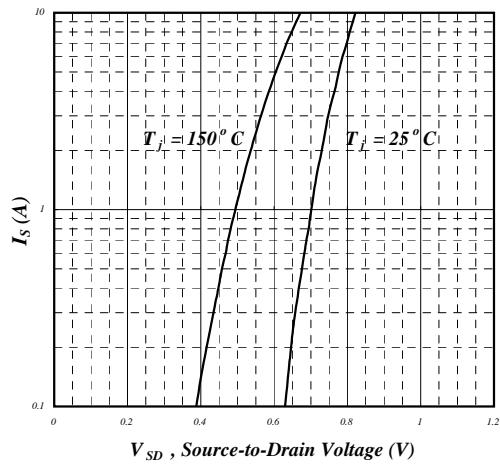


Fig 5. Forward Characteristic of Reverse Diode

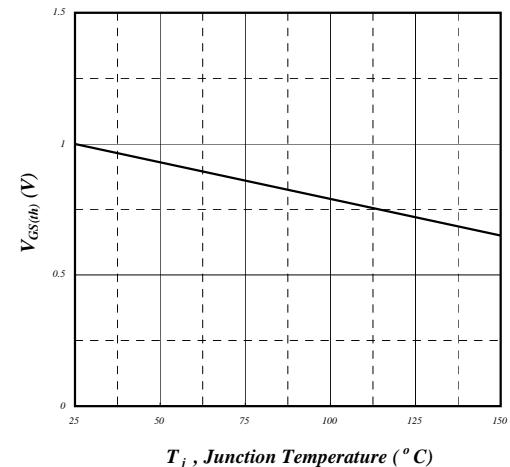


Fig 6. Gate Threshold Voltage v.s. Junction Temperature



AP10N70P/R-A

